



Integrated Device Technology, Inc.  
2975 Stender Way, Santa Clara, CA - 95054

## PRODUCT/PROCESS CHANGE NOTICE (PCN)

PCN #: **L0406-04** DATE: July 15, 2004  
Product Affected: IDT 74SSTV16857

### MEANS OF DISTINGUISHING CHANGED DEVICES:

- ☐ Product Mark  
☐ Back Mark  
☐ Date Code  
☒ Other

Date Effective: July 15, 2004

Contact: Bimla Paul  
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Attachment: ☒ Yes ☐ No

Samples: Available upon request.

### DESCRIPTION AND PURPOSE OF CHANGE:

- ☐ Die Technology To provide improved Tpd timing parameter.  
☐ Wafer Fabrication Process There is no change in die technology/process.  
☐ Assembly Process  
☐ Equipment  
☐ Material  
☐ Testing  
☐ Manufacturing Site  
☒ Data Sheet  
☐ Other

### RELIABILITY/QUALIFICATION SUMMARY:

Not Applicable. This is a data sheet change only

### CUSTOMER ACKNOWLEDGMENT OF RECEIPT:

IDT records indicate that you require written notification of this change. Please use the acknowledgement below or E-Mail to grant approval or request additional information. If IDT does not receive acknowledgement within 30 days of this notice it will be assumed that this change is acceptable.

IDT reserves the right to ship either version manufactured after the process change effective date until the inventory on the earlier version has been depleted.

Customer: \_\_\_\_\_

☐ *Approval for shipments prior to effective date.*

Name/Date: \_\_\_\_\_

E-Mail Address: \_\_\_\_\_

Title: \_\_\_\_\_

Phone# /Fax# : \_\_\_\_\_

### CUSTOMER COMMENTS:

\_\_\_\_\_

### IDT ACKNOWLEDGMENT OF RECEIPT:

RECD. BY:

DATE:



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### ATTACHMENT - PCN #: L0406-04

**PCN Type:** Data Sheet

**Data Sheet Change:** Yes

**Detail of Change:** Revise Tpd timing parameter

**Page 4 of Data Sheet**

**URL:** [http://www1.idt.com/pcms/tempDocs/74SSTV16857\\_datasheet.pdf](http://www1.idt.com/pcms/tempDocs/74SSTV16857_datasheet.pdf)

Symbol	Parameter	From	To
Tpd	CLK and CLK\ to Q	1.1 nsec Min, 2.8 nsec Max	1.1 nsec Min, 2.4 nsec Max